

TX-3535B5FC120-OGVCND34-03F

PRODUCT SPECIFICATION

Features:

- ◆Excellent transiting heat from LED chip operating under 1.5 A.
- ◆High luminous output.
- ◆No UV.
- ◆Encapsulated materials are environmentally certified and meet environmental requirements.

Chip Material:

- ◆GaN

Emitting Color:

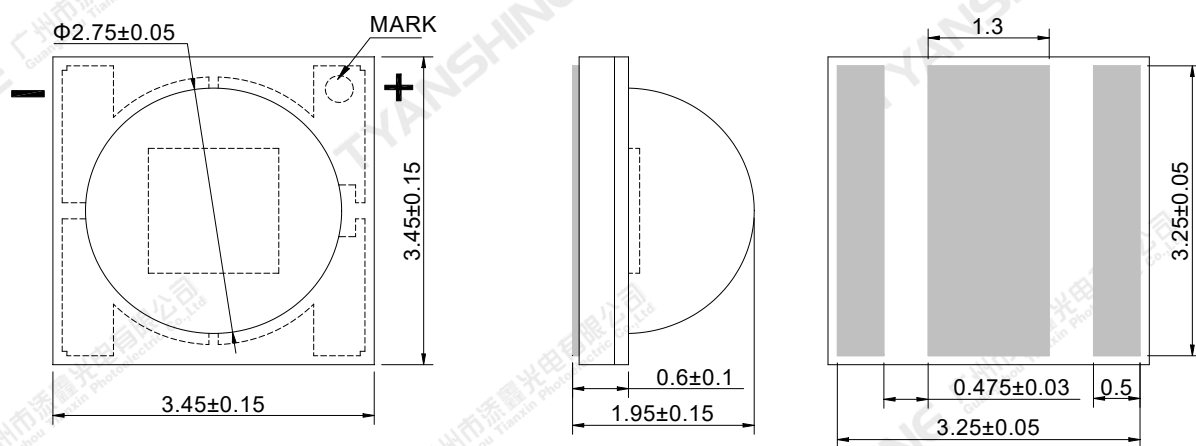
- ◆Blue

Applications:

- ◆Portable Flashlight
- ◆Garden lighting
- ◆General Lighting

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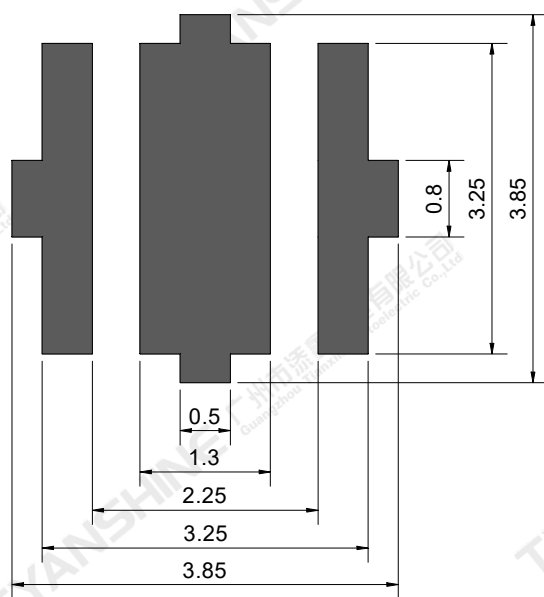
Package Dimensions:



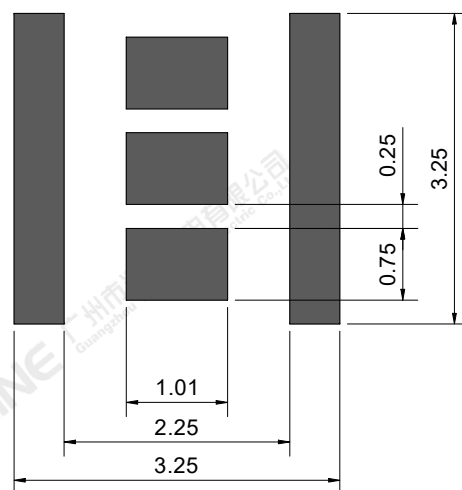
Top view

Side view

Bottom view



Recommended solder pad



Recommended stencil pattern

Notes:

1. All dimensions are in millimeters .
2. Tolerances unless otherwise mentioned are ± 0.1 mm .

Absolute Maximum Ratings (Tc=25℃)

Parameter	Symbol	Ratings	Unit
Forward Current	IF	1500	mA
Reverse Voltage	VR	5	V
Reverse Current	IR	2	μA
Power Dissipation	PD	5700	mW
Junction Temperature	Tj	150	℃
Electrostatic Discharge Threshold (ESD)	ESD	2000	V
Storage Temperature	Tstg	-40~+70	℃
Operation Temperature	Topr	-30~+100	

Notes:

- 1.Specifications are subject to change without notice.
- 2.The data on this specification is for reference only and the actual data is in accordance with the acknowledgment.
- 3.Precautions for ESD:
STATIC SHIELD Electricity and surge damages the LED. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

Electrical Optical Characteristics

Parameter	Symbol	Condition	Min.	Typ.	Max.	Units
Luminous Flux	Φ_v	If=700mA	32	36	—	lm
Forward Voltage	V_f		2.9	3.3	3.7	V
Peak Emission Wavelength	λ_p		443	448	453	nm
Dominant Wavelength	λ_d		447	452	457	nm
Spectral Line Half-Width	$\Delta\lambda$		15	20	25	nm
Viewing Angle at 50 % IV	$2\theta_{1/2}$	—	—	120	—	Deg
Reverse Current	I_R		—	—	2	μA
Thermal Resistance Junction to Case	$R\theta_{J-C}$		—	6.0	—	K/W
Temperature Coefficient of Voltage	$V\Delta F/T$	If=700mA	—	-1.3	—	mV/°C

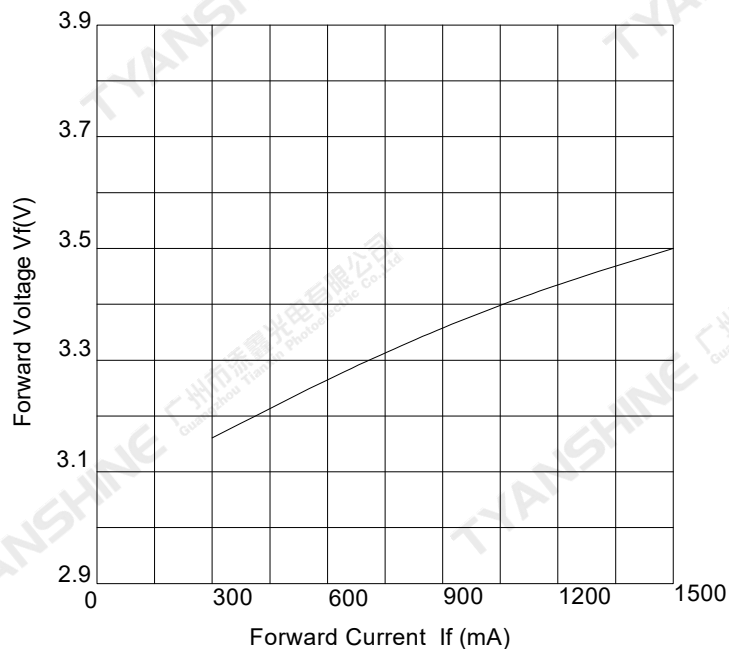
Notes:

- 1.Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3.Luminous flux measurement tolerance: $\pm 15\%$.
- 4.Forward voltage measurement tolerance: $\pm 0.15V$.

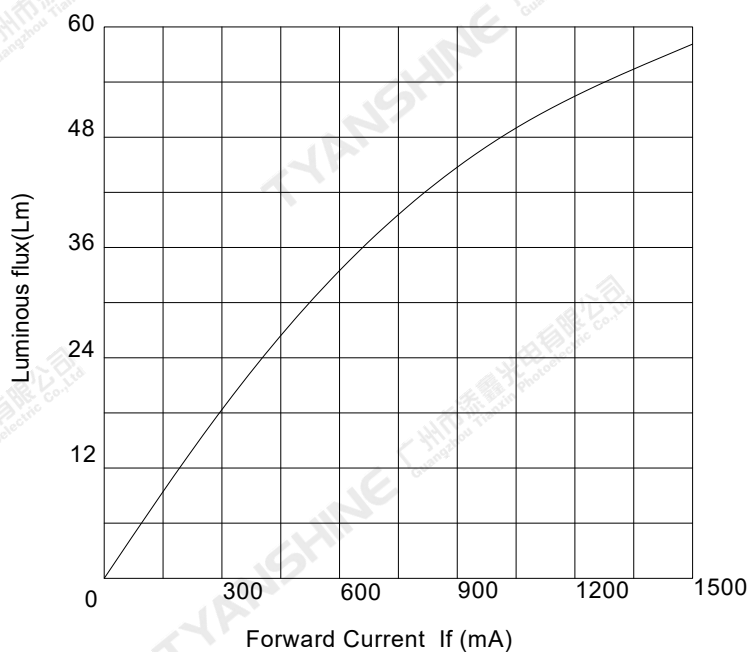
Typical Electrical/Optical Characteristics Curves

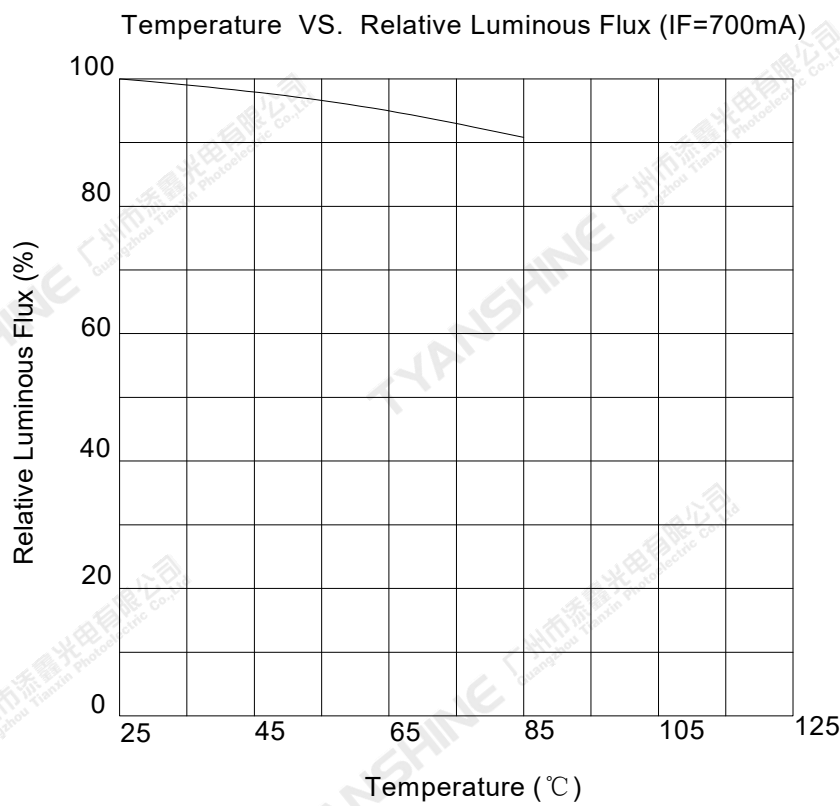
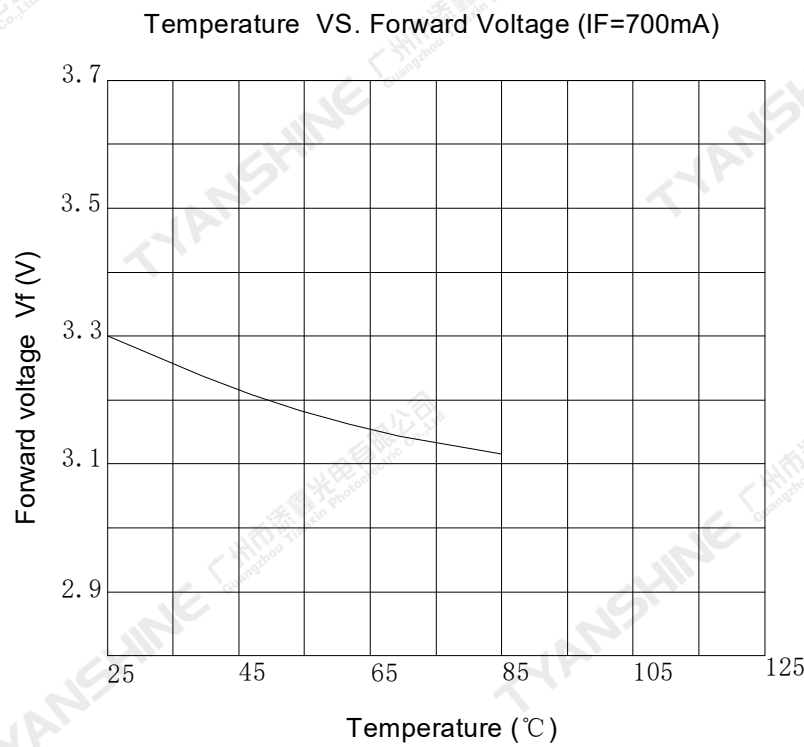
(25°C Ambient Temperature Unless Otherwise Noted)

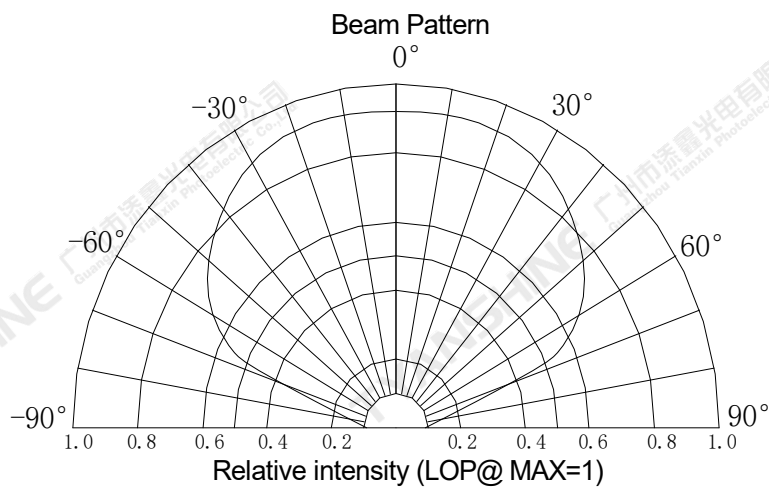
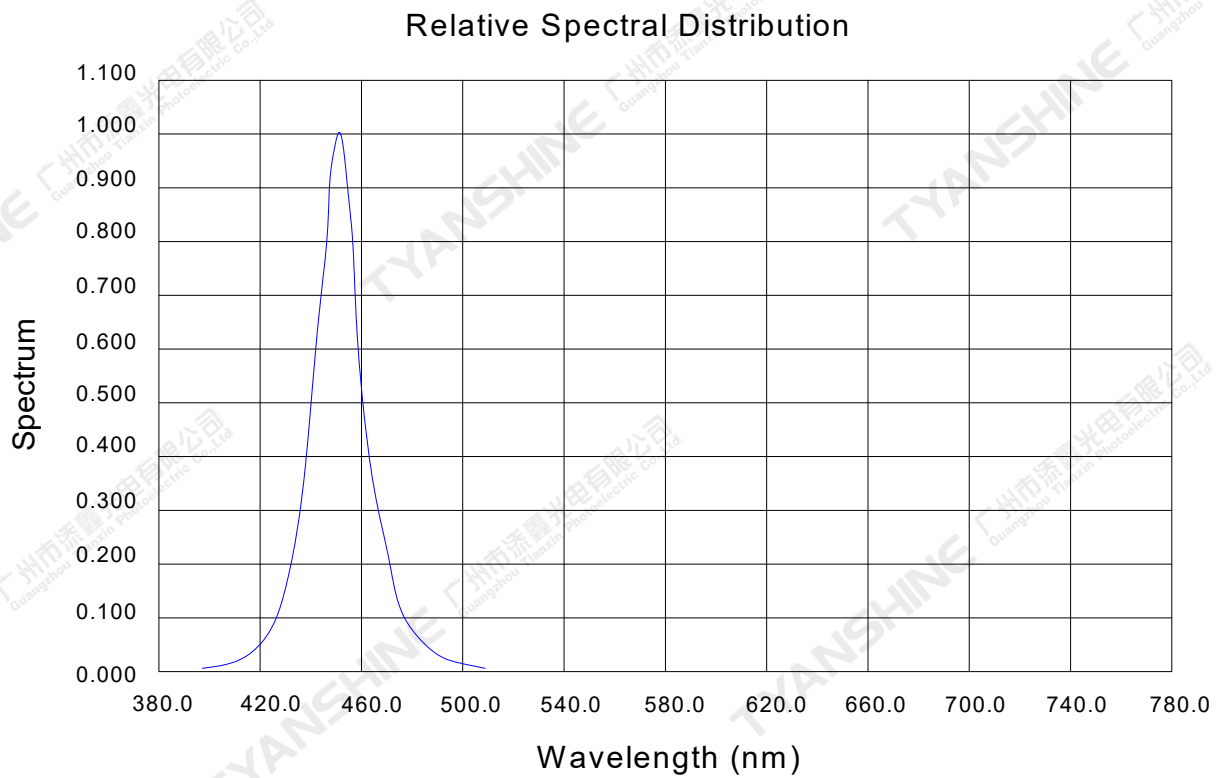
Forward Current VS. Forward Voltage



Forward Current VS. Luminous flux







Notes:

1. 2θ 1/2 is the off axis angle from lamp centerline where the luminous intensity is 1/2 of the peak value.
2. View angle tolerance is ± 5°.

Usage Precautions

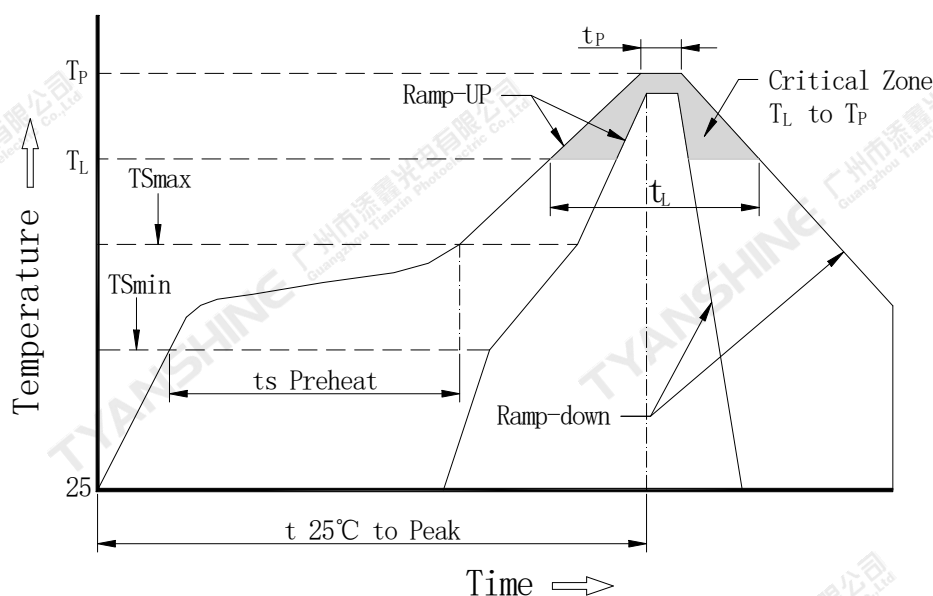
Storage Environment Condition

Temperature: 5°C ~ 30°C (41°F ~ 86°F)

Humidity: 60% RH Max.

Soldering Condition

Use the conditions shown to the under figure.



Profile Feature	Pb-Free Solderr(SnBi35Ag0.3)
Average Ramp-Up Rate (T_{Smax} to T_P)	3°C/second max.
Preheat: Temperature Min (T_{Smin})	130°C
Preheat: Temperature Max (T_{Smax})	190°C
Preheat: Time (T_{Smin} to T_{Smax})	120-180 seconds
Time Maintained Above: Temperature (T_L)	230°C
Time Maintained Above: Time (T_L)	60-150 seconds
Peak/Classification Temperature (T_P)	255°C
Time Within 5°C of Actual Peak Temperature (T_P)	10-35seconds
Ramp-Down Rate	5°C/second max.
Time 25°C to Peak Temperature	7 minutes max.

Note:

All temperatures refer to topside of the package, measured on the package body surface.

Quantity:1000 PCS



1. All dimensions are in millimeters.
2. Tolerances are ± 2.0 mm unless otherwise noted.
3. The products are packaged together with silica gel, Transport, not to the weight of welding LED light-emitting area, As a result of the weight of LED light-emitting zone in the quality of, Irresponsible of the Company.